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	DECLARA	TION FOR PATENT APP		
	•		Ducket No	
As a below named inventor, I h	ereby declare that	: .		
My residence, post office addre	ss and citizenship	are as stated below next to my nam	Itd.	
I believe I am the original, first	and sole inventor	(if only one name is listed below)	or an original, first and joint inventor (if plu	ral numes are fisted below) of
		a a patent is sought on the inventior	n entitled:	
SEMICONDUCTOR DE	VICE			<u>· </u>
				
	•			•
the specification of which				
(check one)	[X is attached		•	
	[] was filed or	n	as	i
	• • •	Serial No.		
	and was am	ended on		(if applicable).
				. 1. 11
I hereby state that I have review	ved and understan	d the contents of the above identifi-	ed specification, including the claims, as am	ended by an amendment
referred to above.				
I acknowledge the duty to disci	lose information w	which is material to the examination	of this application in accordance with Title	37, Code of Pederal
Regulations §1.56(a).				and a manifestation of the company
I hereby claim foreign priority	benefits under Tit	le 35, United States Code, §119 of	any foreign application(s) for patent or inve	nor's certificate fisted below
and have also identified below	any foreign applic	ation for patent or inventor's certifi-	icate having a filing date before that of the a	ppheation on which priority
is claimed:		·	•	
				Priority Claimed
Prior Foreign Application(s)		Tonna	25/5/2001	Yes XXX
156540/2001		<u>Japan</u>	(Day/Month/Year Filed)	- ()
(Number)		(Country)	(Day/Months real rines)	
	•			Yes No
		(Country)	(Day/Month/Year Filed)	
(Number)		(Country)	(52)/	•
			• .	Yes No
(A)		(Country)	(Day/Month/Year Filed)	<u>.</u>
(Number)		(Country)	(,	
Code, §112, I acknowledge the	duty to disclose r	in the prior United States application material information as defined in 1 tional or PCT international filing defined in the prior of	on in the manner provided by the first paragrilitle 37, Code of Federal Regulations §1.56(ate of this application:	iph of Title 35, United States a) which occurred between
(A) Constant Stantal	No.)	(Filing Date)	(Status-patented, pending, aband	oned)
(Application Serial	140.)	(1 mile Date)	, <u>.</u>	
			·	
(Application Serial	No.)	(Filing Date)	(Status-patented, pending, aband	oned)
				•
Michael Markowitz Rev. No.	. 30.659. Brian M	Avers, Reg. No. 49,947, Harris Wo	son Helfgott, Reg. No. 23,072, Linda S. Cl olin, Reg. No. 39,432, Shahan Islam, Reg. and to transmit all business in the Patent and	No. 32,507, Emma Smener,
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			Madison Avenue	
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		Tele	phone No.: (212) 940-8800	•
the and further that these stat	section 1001 of Ti	e with the knowledge that willful fa itle 18 of the Untied States Code an	that all statements made on information and alse statements and the like so made are punit distributed willful false statements may jeop	snable by line or
Inventor's Signature Ma	ato Kim	44/8 (+++) D.	May 14, 2002	
Residence Kumamoto,			Japanese Victoria chi	Kumamoto,
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